

### TCXO HIGH STABILITY 105 °C HIGH TEMPERATURE





Product Number

TG-5510CA: X1G006001xxxx99 TG-5511CA: X1G006011xxxx99

## TG-5510CA / TG-5511CA

Frequency range
 Supply voltage
 To MHz to 54 MHz
 3.3 V Typ.
 Frequency / temperature characteristics

:  $\pm 0.28 \times 10^{-6}$  Max. (-40 °C to +85 °C, 105 °C option)

Free-run accuracy
 External dimensions
 Applications
 4.6 × 10-6 Max. / 20 years (for Stratum3)
 7.0 × 5.0 × 1.5 mm (10 pins or 4 pins)
 Network synchronization, Stratum3, BTS, SyncE, IEEE1588, Microwave, BTS

•Features : 105 °C High temp, High stability







TG-5511CA (4 pins)

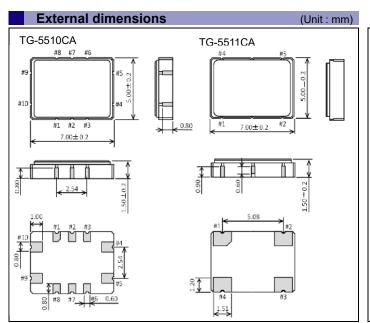
### Specifications (characteristics)

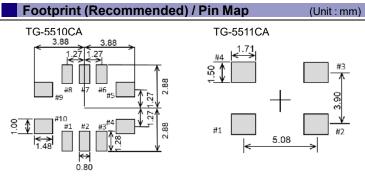
openioalions (characteristics)					
Item	Symbol	CMOS	Clipped sine wave	Condition	
Output frequency range	fo	10 MHz to 54 MHz		Please contact us about available frequencies.	
Supply voltage	$V_{cc}$	3.3 V ± 5 %		·	
Storage temperature	T_stg	-40 °C to +105 °C		Storage as single product.	
Operating temperature	T_use	-40 °C to +85 °C		Standard	
		(-40 °C to +105 °C)		(Option)	
a) Frequency tolerance	f_tol	±1.0 × 10 <sup>-6</sup> Max.		After reflow, +25 °C	
b) Frequency/temperature	fo-Tc	±0.28 × 10 <sup>-6</sup> Max.		Standard	
characteristics		(±0.25 × 10 <sup>-6</sup> Max.)		(Option)	
c) Frequency/load coefficient	fo-Load	±0.1 × 10 <sup>-6</sup> Max.		Load ± 10 %	
d) Frequency/voltage coefficient	$fo-V_{CC}$	±0.1 × 10 <sup>-6</sup> Max.		V <sub>CC</sub> ± 5 %	
e) Frequency aging	f_age	±0.5 × 10 <sup>-6</sup> Max.		+25 °C, First year	
		±3.0 × 10-6 Max.		+25 °C, 20 years	
Holdover stability		±0.01 × 10 <sup>-6</sup> Max. (	+25 °C, 24 hours)	After 10 days of continuous operation	
(Constant temperature)	-	±0.04 × 10 <sup>-6</sup> Max. (	(+25 °C, 24 hours)	After 48 hours of continuous operation	
Wander generation (MTIE, TDEV)		Compliant with GR-1244CORE, ITU-T G.8262			
Free-run accuracy	-	±4.6 × 10 <sup>-6</sup> Max. / 20 years		This includes Item a), b), c), d) and e)	
Current consumption	Icc	7.0 mA Max.	6.0 mA Max.	10 MHz ≤ fo ≤ 26 MHz	
		9.0 mA Max.		26 MHz < fo ≤ 40 MHz	
		10.0 mA Max.		40 MHz < fo ≤ 54 MHz	
Symmetry	SYM	45 % to 55 %	-	GND level (DC cut)	
Output voltage	V <sub>OH</sub>	90 % V <sub>CC</sub> Min.	-	·	
	$V_{OL}$	10 % V <sub>cc</sub> Max.	-		
Rise time / Fall time	tr/tf	8.0 ns Max.	-	10 % V <sub>CC</sub> to 90 % V <sub>CC</sub> level, Load: 15 pF	
Start-up time	t_str	5 ms. Max.		t = 0 at 90 % V <sub>CC</sub>	
Output level	Vpp		0.8 V Min.	Peak to Peak	
Output load condition	Load	15 pF	10 kΩ // 10 pF		
Input voltage	$V_{IH}$	70% V <sub>CC</sub> Min.		OE terminal (Enable voltage)	
	$V_{IL}$	30% V <sub>CC</sub> Max.		OE terminal (Disable voltage)	

<sup>\*</sup> Note: Please contact us for requirements not listed in this specification.

Product Name (Standard form)  $\frac{\text{TG-5510CA}^{+***}}{\boxed{1}} \frac{30.720000\text{MHz}}{\boxed{3}}$ 

①Model ②Package type ③Spec segment (Please contact us) ④Frequency





To maintain stable operation, provide a 0.01  $\mu$ F to 0.1  $\mu$ F by-pass capacitor at a location as near as possible to the power source terminal of the crystal product (between V<sub>CC</sub> - GND).

Pin	Connection	
1, 2, 3, 6, 7, 10	N.C.	
4	GND	
5	OUT	
8	OE	
a	Voc	

OE pin = "H" or "open": Specified frequency output. OE pin = "L" : Output is high impedance.

Pin	Connection
1	N.C
2	GND
3	OUT
4	V <sub>CC</sub>

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All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

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IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

Explanation of the mark that are using it for the catalog



►Pb free.



► Complies with EU RoHS directive.

\*About the products without the Pb-free mark.

Contains Pb in products exempted by EU RoHS directive.

(Contains Pb in sealing glass, high melting temperature type solder or other.)







▶ Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc.).

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